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Published in:
12th European Conference on Antennas and Propagation (EuCAP 2018)

DOI:
10.1049/cp.2018.0443

Published: 10/12/2018

Please cite the original version:
Roll-to-Roll Reverse Offset Printing of Millimeter-wave Transmission Lines and Antennas on Flexible Substrates

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Abstract—We investigate the feasibility of roll-to-roll reverse offset (R2R-RO) printing technology for the mass fabrication of millimeter-wave antennas on flexible substrates. In this study, samples of coplanar waveguide (CPW) transmission lines and microstrip patch antennas were manufactured and measured. The results indicate that the R2R-RO printing technique can be an excellent candidate for the production of millimeter-wave and terahertz devices, since it has the advantage of low cost and high resolution.

Index Terms—millimeter wave, roll-to-roll printing, flexible substrate, antenna, measurement.

I. INTRODUCTION

Recently, the topics of Internet of Things (IoT) and the fifth generation (5G) have been becoming more and more popular. In order to meet the requirements of data traffic, millimeter-wave (mm-wave) technology has been recognized as a key technology in IoT and 5G communications systems. They need low-cost electronics with high performance and smaller dimensions. Mm-wave technology, however, has been too expensive to adapt it to consumer products.

Printed electronics has advantages in terms of weight, flexibility, and ease of integration into portable devices and several state-of-art achieved results have been summarized [1]–[4]. Many high-resolution printing methods have been proposed, but so far they are limited by the line resolution, materials, low speed, or insufficient aligning accuracy [5]–[7].

In this work, we aim at developing the roll-to-roll reverse offset (R2R-RO) technology to make the manufacturing process possible for millimeter-wave structures. Coplanar waveguide (CPW) transmission lines and microstrip patch antennas printed by R2R-RO printing technology have been investigated, fabricated, and measured.

II. CPW TRANSMISSION LINES

In the process of R2R-RO printing, the conductive ink is applied on a polydimethylsiloxane (PDMS) blanket wrapped around a cylinder. Stamp on another cylinder takes part of the ink away, whereas the remaining ink on the stamp forms the pattern on the substrate (Fig. 1) [8]. To ensure the flat conducting ink layer with even thickness in large printing areas, some pillar-shape structures are necessary for the manufacturing. These are shown as holes on the printed ink layer.

The substrates used in our printing experiments are Polyethylene Naphthalate (PEN) substrates with thickness of 125 µm and with measured dielectric constant \( \varepsilon_r = 3.2 \) and loss tangent \( \tan \delta = 0.045 \) at 90 GHz [9]. The printed silver nanoparticle ink is sintered producing metal layers resistivity of \( \rho \approx 2.5 \times 10^{-7} \, \Omega\cdot\text{m} \) or conductivity of \( \sigma \approx 4 \times 10^6 \, \text{S/m} \). When taking into account the sintered ink layer thickness of 300 - 400 nm, we use the sheet impedance of square impedance \( \leq 1 \, \Omega/\text{sq} \), representing the ability of ink to conduct electricity.

A. CPW Design

CPW is used widely as a transmission line in mm-wave frequency band structures, and it is the simplest structure for measuring in the probe station environment. Therefore, we investigate the CPW transmission lines with holes on the conductor layer applicable for the R2R-RO printing technology in the frequency range of 67-110 GHz which covers the full W-band (75-110 GHz).
The dimensions of CPW we choose for the 50 Ω characteristic impedance on the PEN substrate \((h = 125 \text{ µm}, \epsilon_r = 3.2)\) are: signal line width \(w_{\text{cpw}} = 150 \text{ µm}\) and gap width \(w_{\text{gap}} = 13 \text{ µm}\). With the holes on the metal layer, the physical structure of the CPW will be changed, so we need to optimize the parameters of the holes to keep the CPW performance stable. Depending on different printing directions \((x\) and \(y)\), we put periodical holes in the metal layer. The radius of the holes is \(r = 10 \text{ µm}\), and the distances between the holes in two orthogonal directions are 60 µm and 100 µm (Fig. 2). To reduce the effect on surface currents on the CPW signal line edge, we removed some holes in Fig. 2(d) (reduced holes). Since the conductivity of ink is not as good as that of the perfect electric conductor (PEC), we set the square impedance of conducting ink to \(R = 1 \Omega/\text{sq}\) as a reference.

Fig. 2: (a) CPW full covered with metal (no holes); (b) with holes \(dx=60 \text{ µm}, dy=100 \text{ µm}\); (c) with holes \(dx=100 \text{ µm}, dy=60 \text{ µm}\); (d) holes \(dx=60 \text{ µm}, dy=100 \text{ µm}\) (with reduced holes).

A set of 2-mm-long CPW transmission lines (with and without holes) were designed with square impedance \(R = 1 \Omega/\text{sq}\). The simulated results of S-parameters are shown in Fig. 3. Since the CPW transmission lines are symmetric 2-port passive devices, only results from port 1 are plotted. The reflection coefficient \(S_{11}\) in all cases is below -20 dB in the full frequency range. The transmission coefficient \(S_{21}\) for the case of CPW with holes in the metal layer is a bit lower than that of when it is fully covered with conducting ink, because the hole structure affects the surface current distribution on the CPW signal line and increases the equivalent sheet impedance. Thus, the more holes on the CPW signal line \((dx = 60 \text{ µm}, dy = 100 \text{ µm})\) in Fig. 2(b)), the worse the sheet impedance becomes (yellow dot line in Fig. 3).

B. CPW Measurement

Microscope views of the fabricated CPW transmission lines under the probe station measurement environment are shown in Fig. 4. The holes are periodically located along the two orthogonal edges. The overall manufacturing quality of R2R-RO printing is very excellent, which can reach a resolution of ≤ 10 µm.

We measured the CPW transmission lines with on-wafer ground-signal-ground (GSG) probes. The measured results of two chosen CPW samples are shown in Fig. 5. It is clear that the reflection coefficients \(S_{11}\) are less than -15 dB in the full frequency range. The level of the transmission coefficients \(S_{21}\) is a little higher than the simulated one, which indicates that the practical conducting ink has a sheet impedance less than 1 \(\Omega/\text{sq}\). Another reason could be that the actual loss tangent of PEN substrates is lower than the measured value in [9]. It is worth mentioning that the measured \(S_{21}\) parameters show the same trend as simulated results, i.e. that less holes on CPW signal line will result in less losses.

Fig. 3: S-parameter simulation results of different type of CPW transmission lines with ink sheet impedance \(R = 1 \Omega/\text{sq}\). The length is 2 mm.

Fig. 4: Microscope views of fabricated printed CPW transmission lines fed with GSG probes. (a) \(dx=100 \text{ µm}, dy=60 \text{ µm}\); (b) \(dx=60 \text{ µm}, dy=100 \text{ µm}\) (with reduced holes). The length is 2 mm.

Fig. 5: S-parameter measurement results of CPW transmission lines. The length is 2 mm.
III. MICROSTRIP PATCH ANTENNAS

We have also investigated the feasibility of R2R-RO printing technology on printing large-area structures, i.e. microstrip patch antenna, patch array, and grid antennas. In this paper, a printed microstrip patch antenna is presented.

A. Design and Fabrication

In Section II, we have discussed CPW-type transmission lines. The CPW is also used as the starting part of the feeding structure in the microstrip patch antenna, because in the mm-wave frequency, it is difficult to feed antennas by coaxial lines due to the limited antenna size. We designed a microstrip patch antenna working in the center frequency of 77 GHz. Some basic parameters of the antenna in this design are: the 50 Ω microstrip line width \( w_{\text{ms}} = 0.28 \) mm, sizes of patch \( l_{\text{patch}} = 1.8 \) mm and \( w_{\text{patch}} = 1 \) mm (Fig. 6(a)). Like CPW transmission lines, the same periodically situated holes are also added in the metal layer.

A microscope view of printed microstrip patch antenna is depicted in Fig. 6(b). It is clearly seen that the antenna has been printed with a very good dimensional quality.

B. Simulation and Measurement Results and Analysis

Similarly to CPW transmission line measurements, we measured the microstrip patch antenna on the on-wafer probe station in the frequency range of 67-110 GHz. Both the reflection coefficient \( S_{11} \) and the realized gain were measured.

1) Reflection Coefficient Measurement: The simulated reflection coefficient \( S_{11} \) of the designed antenna is presented by the blue dash line in Fig. 7, and it has the first resonance frequency of 77 GHz. The measured \( S_{11} \) is shown as the yellow solid line in Fig. 7, which has the first resonance frequency of 81 GHz. There is a frequency shift between the simulated and measured results. Possible reason for this is explained later.

2) Realized Gain Measurement: Due to the limitation of the set-up in the probe station, we can not measure the antenna radiation pattern with a rotator. Alternatively, we only measured the maximum realized gain in the broadside direction, i.e. in the angle \( (\theta = 0^\circ, \phi = 0^\circ) \), where the main beam of the designed microstrip patch antenna is pointing at. The method we used for the gain measurement is presented in [10].

The simulated realized gain-frequency curve is the blue dash line in Fig. 8. The realized gain peaks at a little higher frequency than the designed resonance frequency 77 GHz. The simulated realized gain value is 4.5 dBi at 77 GHz, whereas it peaks at 79 GHz with level of 4.8 dBi. The measured simulated realized gain-frequency curve is shown in Fig. 8 (yellow solid line). It is clear that compared with the simulated gain curve, the measured realized gain has a frequency shift leading to a good radiation at the resonance frequency of about 81 GHz and the peak value is 4.5 dBi at 84 GHz.

3) Analysis of Measured Realized Gain: In Section III-B1 and Section III-B2, we observe that there is a frequency shift between simulated and measured results for the microstrip patch antenna. The structural dimensions of the fabricated samples are measured and they follow very accurately the designed values. Also, the thickness of the substrate was measured and it is close to nominal 125 µm within few micrometer accuracy. According to the simulation, the small discrepancy in thickness has negligible effect on the performance of the antenna. Therefore, dimensional inaccuracies are not seen as the reason for the frequency shift. In addition, we
have estimated how the change in the substrate permittivity affects the resonance frequency. The simulation shows the observed resonance frequency corresponds to the substrate permittivity of 2.8. We have made further measurement for the material parameters, verifying the dielectric constant of the PEN substrate is 3.2 with an accuracy of 0.1.

Instead of discrepancy in material properties or dimensions, we suspect the measurement environment to be the cause of the frequency shift. The designed antenna has a perfect ground (GND), but the fabricated sample does not have a GND on the back side, and we use the steel chuck of the probe station as the GND. In this situation, there could be a small air gap between the metal surface and the bottom of the PEN substrate. To analyze quantitatively, we have done simulations and varied the air gap. The measured and simulation results agree best when the air gap is 12 µm. The simulated $S_{11}$ and realized gain curves are shown as the red dot lines in Fig. 7 and Fig. 8. In this case, the measured results match the simulated results excellently.

**IV. CONCLUSION AND FUTURE WORK**

CPW transmission lines and microstrip patch antennas based on R2R-RO printing technology have been designed, fabricated, and measured. The process is cost-effective with excellent resolution and can be suitable for large-area printing. The performances of the designed CPW and antennas satisfy the expectations. For example, the printed patch antenna has a measured peak realized gain of 4.5 dBi. R2R-RO printing technology is a good candidate for the fabrication of IoT and 5G devices.

Future work is still needed: e.g., to improve ink conductivity and fabricate metal GND layer on the back side of substrates to ensure good quality ground plane for the patch antenna.

**ACKNOWLEDGMENT**

The authors would like to thank Xuchen Wang for discussions and Mikko Heino for his help in the development of antenna measurement system.

This work is supported by Academy of Finland project #288145 (LATERA) and partly by Chinese Scholarship Council (CSC).

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